

Pulp and Paper Industries Technical Conference Young Engineering Professionals Program

One of the challenges the Pulp and Paper Industry faces going forward is attracting and retaining new, young electrical engineering professionals to the industry. Recognizing this need, the IEEE Pulp and Paper Industry Committee (PPIC) has arranged with the IEEE Industrial Applications Society (IAS) to provide a limited number of partial financial sponsorships for young engineers to attend to their upcoming Annual Conference.

This provides a low cost way for young engineering professionals to experience this forum for the exchange of electrical applications technology relating to forest products based industries. This is a great way to meet other industry engineers, learn solutions to real mill needs, and network with senior professionals from the industry.

What is included?

- ✓ Free Conference Registration
- ✓ One Tutorial
- ✓ Conference Reception
- ✓ Vendor Exhibition
- ✓ Meals at the Conference
- ✓ Free First year of IEEE and IAS Membership

What are the requirements?

- Full time employee of a Pulp and Paper Products Industry end-user (Pulp, Paper, Board, Tissue, etc.) or consulting engineer working in support of clients in the industry.
- Less than 5 years of experience in the Industry.
- Have never attended a IEEE Pulp and Paper Industries Technical Conference previously.
- The young engineer must attend one PPIC sub-committee meeting and the general committee meeting on Tuesday.
- You or your employer are responsible for all travel and hotel costs, and will receive a \$500 stipend after attendance.
- Conference Registration and IEEE Membership will be refunded after you attend the Conference. If you are unable to attend after registering, normal cancellation policy will be in effect.

A few highlights from the Conference:

- We begin with the Welcome Reception at the hotel on Sunday Night.
- Some great technical papers and very interesting tutorials will be presented during the Conference.
- Many vendor booths will be available to visit throughout the conference.
- The Wednesday Conference Awards Dinner & Closing Event is a fun event to finish the Conference.
- The PPIC Subcommittee meetings are on Tuesday from 12:00pm until 5pm. The subcommittees are where the papers, tutorials, and other topics are generated for upcoming conferences.



We have four subcommittees consisting of:

- DCS Drives and Control Systems
- PCEMC Process Control, Engineering, Maintenance and Construction
- PDS Power Distribution Systems
- S&T Safety and Training

We also have a Standards Committee, which is currently developing a Recommended Practice for Specifying AC Coordinated Adjustable Speed Drive Systems for Operation on 3 Phase AC 50/60 Hertz up to 1000 Volts for Pulp and Paper Industry Installations

Visit www.pulppaper.org for more information on the Conference!

Please fill out the following:

Name	
Title (Electrical Engineer, Reliability Engineer, etc.)	
IEEE Member number, if already a member	
Active email address	
Phone number	
Company	
Company Location (Mailing Address)	
College	
Degree and Graduation Date	
Subcommittee Preference	

If you are not currently a member of IEEE and the IAS, you will be required to sign up for IEEE before attending the conference and will be reimbursed after the conference. IAS application will be completed at the conference.

The final selection of the successful applicants will be based on the qualifications listed above, the order that the applications were received, and how many applicants there are from different companies. Successful applicants will be notified as quickly as possible.

Please return this application by **MAY 10** via e-mail to:

Emily Held
emily.held@ipaper.com
541-731-0432